

FMKA140

Features

- Compact surface mount with J-bend leads (SMA)
- 1.2 Watt Power Dissipation package
- 1.0 Ampere, forward voltage less than 600 mV



SMA (D0-214AC) Color Band Denotes Cathode Mark: A140

Schottky Rectifier

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	40	V
I _{F(AV)}	Average Rectified Forward Current @ T _L = 120°C	1.0	А
I _{FSM}	Non-repetitive Peak Forward Surge Current	30	A
T _{stg}	Storage Temperature Range	-65 to +150	°C
T _j	Operating Junction Temperature	-65 to +125	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JL}$	Thermal Resistance Junction to Lead (Half wave, single phase, 60 Hz) 9.6 °C/W		°C/W

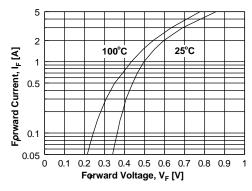
Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter		Value	Units
V_{F}	Forward Voltage	$@ I_F = 1.0A,$	600	mV
I _R	Reverse Current	@ V _R = 40 V, V _R = 40 V, T _A = 100 °C	1.0 10	mA mA

Schottky Rectifier

(continued)

Typical Characteristics



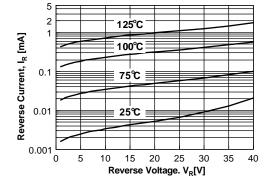


Figure 1. Forward Voltage Characteristics

Figure 2. Reverse Current vs Reverse Voltage

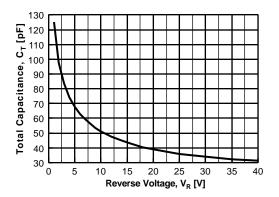


Figure 3. Total Capacitance

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